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DFLU1200

Features and Benefits

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- ±2kV ESD Protection (IEC61000-4-2, Contact Discharge)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

1.0A SURFACE MOUNT SUPER-FAST RECTIFIER PowerDI[®]123

Mechanical Data

- Case: PowerDI[®]123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.01 grams (approximate)



Top View

Ordering Information (Note 3)

Device	Packaging	Shipping
DFLU1200-7	PowerDI [®] 123	3000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. For packaging details, visit our website at http:// www.diodes.com/products/packages.html

Marking Information



F15 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Notes:

Duic Cou	o noy														
Year	2005	2006	2007	2008	2009	2010	2011	2012	20	13 20 ⁻	14 20	15	2016	2017	2018
Code	S	Т	U	V	W	Х	Y	Z	A	۱ E	3 (5	D	E	F
Max		lan	Fab	Man	A	Max				A	Can		0-4	Nau	Dee
	ntn	Jan	Feb	war	Apr	way	Ju	n ,	Jui	Aug	Sep		UCT	NOV	Dec
Co	de	1	2	3	4	5	6		7	8	9		0	Ν	D



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load

For capacitive load, derate current by 20%.						
Characteristic	Symbol	Value	Unit			
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 3)	V _{RRM} V _{RWM} V _R	200	V			
RMS Reverse Voltage	V _{R(RMS)}	140	V			
Average Rectified Output Current (see figure 4)	Io	1.0	A			

Thermal Characteristics

Characteristic		Symbol	Typ	Max	Unit
	@ T 0500	Oymbol	Typ	1.0	0111C
Power Dissipation (Note 5)	@ I _A = +25°C	PD	—	1.0	VV
Thermal Resistance Junction to Soldering Point (Note 6)		$R_{\theta JS}$	—	6	°C/W
Thermal Resistance Junction to Ambient (Note 5)	$@T_A = +25^{\circ}C$	$R_{ extsf{ heta}JA}$	116	—	°C/W
Thermal Resistance Junction to Ambient (Note 7)	@T _A = +25°C	$R_{ extsf{ heta}JA}$	182	_	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150		°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Forward Surge Current 8 Single Half Sine-Wave Superimposed on Rate	3.3ms ed Load	I _{FSM}	30	А
Forward Voltage Drop	@ I _F = 0.6A @ I _F = 1.0A	V _{FM}	0.90 0.98	V
Peak Reverse Current at Rated DC Blocking Voltage (Note 4)	@ T _A = +25°C @ T _A = +100°C	I _{RM}	5.0 200	μΑ
Reverse Recovery Time (Note 8)		t _{rr}	25	ns
Typical Total Capacitance (f = 1MHz, V _R = 4VDC)			27	pF

Notes: 4. Short duration pulse test used to minimize self-heating effect.

5. Device mounted on 1" x 1", Polymide PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document AP02001.pdf.

6. Theoretical R_{0JS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.

7. Device mounted on FR-4 PCB, 2 oz. Copper, minimum recommended pad layout pattern per http://www.diodes.com/datasheets/ap02001.pdf 8. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See figure 7.



DFLU1200











Fig. 7 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI [®] 123							
Dim	Min	Max	Тур				
Α	3.50	3.90	3.70				
В	2.60	3.00	2.80				
С	1.63	1.93	1.78				
D	0.93	1.00	0.98				
Е	0.85	1.25	1.00				
Н	0.15	0.25	0.20				
L	0.40	0.50	0.45				
L1	-	-	1.35				
L2	-	-	1.10				
L3	-	-	0.20				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4



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